

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	119	(driv\$3 near IC) with (flip near chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 14:46
L2	56	(driv\$3 near IC) with (flip near chip near (bond\$3 mount\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:23
L3	3	("4616408" "4734563" "4841120").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/10 15:22
L4	32	(driv\$3 near IC) and (flip near chip near (bond\$3 mount\$3)) and (power near2 (chip die circuit device))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:36
L5	1	(driv\$3 near IC) and (flip near chip near (bond\$3 mount\$3)) and ((mos mosfet) near2 (chip die circuit device))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:38
L6	160	(driv\$3 near IC) and (flip near chip near (bond\$3 mount\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:38
L7	160	(driv\$3 near IC) and (flip near chip near (bond\$3 mount\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:52
L8	11783	(flip near chip near (bond\$3 mount\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:52
L9	11868	(flipchip (flip near chip)) near (bond\$3 mount\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:53

L10	879	9 and (driv\$3 near (IC chip die circuit mos mosfet mis misfet device))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:55
L11	222	10 and ((power switch\$3) near (IC chip die circuit mos mosfet mis misfet device))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:55
L12	100	11 and module	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/10 15:55
L13	13	("5002818" "5396403" "5471366" "5710733" "5866943" "5900312" "6011697" "6060150" "6212074" "6275381" "6285078" "6348679" "6496373").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/10 16:00